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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Frank A. Baiocchi  
Application No: 10/673,539  
Filed: 09/29/2009  
Art Unit: 2818  
Docket No.: TI-68031  
Conf. No.: 1844

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<b>NAME OF INVENTOR(S):</b> <b>Frank A. Baiocchi</b>	
<b>TITLE OF INVENTION:</b> <b>Metal-Oxide-Semiconductor Device With Enhanced Source Electrode</b>	
<b>TI FILE NO.:</b> <b>TI-68031</b>	<b>DEPOSIT ACCT. NO.:</b> <b>20-0668</b>
<b>FAXED:</b> 07/17/2009 <b>DUE:</b> --- <b>ATTY/SECY:</b> lgs	
<b>RECEIPT DATE &amp; SERIAL NO.:</b> <b>Serial No.: 10/673,539</b> <b>Filing Date: 09/29/2009</b>	

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